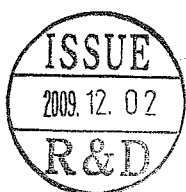




帛江科技股份有限公司

BO-JIANG TECHNOLOGY CO., LTD.

PRODUCT SPECIFICATION (產品規格書)

PART NO.(圖號)	9715NS502BD000B	DATE (日期)	2009 / 12 / 02	
TITLE(產品名稱)	MMCX PCB MOUNT PLUG			
MATERIAL AND FINISH(材質及表面處理)				
DESCRIPTION(名稱)	MATERIAL(材質)	FINISH(表面處理)		
Center Contact(中心導體)	BRASS	30 μ" GOLD		
Insulator(絕緣體)	TEFLON	WHITE		
Outer Contact(外導體)	BRASS	3 μ" GOLD		
Others(其它)				
ELECTRICAL(電氣特性)				
項目	測試條件	測試規格		
Impedance(阻抗)	0 ~ 6 GHz	50 Ω		
Voltage Standing Wave Ratio(VSWR)(駐波比)	0 ~ 6 GHz	1.2 Max.		
Dielectric Withstanding Voltage(絕緣耐電壓)	DC, time: 60sec	500 Vrms Min.		
Contact Resistance (導體阻抗)	Center Contact (中心導體)	DC 0.2V, 1A	5 mΩ Max.	
	Outer Contact(外導體)	DC 0.2V, 1A	2.5 mΩ Max.	
Insulation Resistance(絕緣阻抗)	DC 500V, time: 60sec	1000 MΩ Min.		
MECHANICAL(機械特性)				
項目	測試條件	測試規格		
Force To Engage/Disengage(接合力/脫離力):	N/A	1.4 lbs. ~ 8 lbs.max.		
Contact Retention(中心導體承受力):	60mm/min	2.3 lbs. min.		
REMARKS(備註)				
<p>1. Between BODY (NO.1) And INSULATOR (NO.2) Must Withstand A 2.3 lbs. Min. Axial Force. (軸向力測試)。</p> <p>2. Between BODY (NO.1) And RETAINER RING (NO.4) Must Withstand A 8 lbs. Min. Axial Force. (軸向力測試)。</p>				
				
A	N/A	<i>[Signature]</i>	<i>[Signature]</i>	Alicia
Issue 版本	Revision 修改記錄	Approved 核准	Checked 審核	Drawn 製定